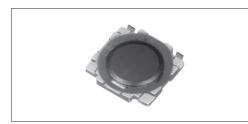
4.8×4.8mm with height of 0.55mm. Compact & low-profile





Typical Specifications		
Items	Specifications	
Rating (max.)	50mA 12V DC	
Rating (min.)	10µA 1V DC	
Initial contact resistance	100mΩ max.	

Product Line

Product No.	Operating force	Operating direction	Travel (mm)	Operating life (5mA 5V DC)	Minimum order unit (pcs.)	
FIOUUGENO.	Operating force				Japan	Export
SKRBAGE010	1.1N		0.15	2,000,000 cycles		
SKRBAAE010	1.57N	Top push		1,000,000 cycles	10.000	10,000
SKRBACE010	2.55N	rop push	0.2	500,000 cycles	10,000	10,000
SKRBAKE010	3.5N			200,000 cycles		

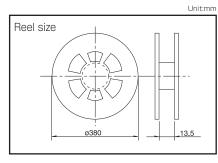
Packing Specifications

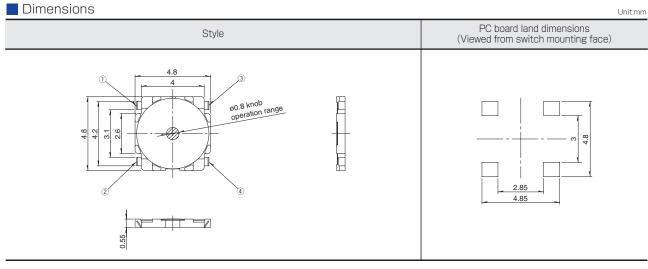
Taping

Number of packages (pcs.)			Tape width	Export package	
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)	
10,000	100,000	100,000	12	401×401×214	

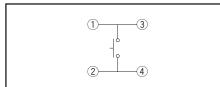
Note

For reels of 330mm diameter, please inquire.





Circuit Diagram





Refer to P.259 for soldering conditions.

Soft Feeling

Sharp Feeling

TACT Switch

TACT Switch[™] List of Varieties

	Туре					eeling Type			
	Series	SKSH	SKRW	SKRM	SKRB	SKRR	SKQG	SKTC	SKSK
	Photo		\bigcirc		۲				
	Features		Low-	profile		Low-profile and long life	Low-profile	Double	action
	Water-proof	_	_	_	_			•	_
	Dust-proof	_		_	_			•	_
	IP standard	_		_	_	_	_	67 equivalency	_
Operatir	Top push	٠	•	•	•	•	•	•	•
directio		_		_	_				_
	W	3.3				7.5		3.4	3.5
Dimensic (mm)	ons D	2.9	□3.7	□4.5	□4.8	7	□5.2	2.2	3.2
(11111)	Н	0.	35	0.4	0.55	0.6	0.8/1.5	0.62	0.6
Operatio force coverag	2N to 3N	ţ	Ĵ	1		\$		See the relev respective descri	e product
	Travel (mm)	0.	15	0.15	0.2	0.	25	See the relevant respective production	
G	round terminal	_	_	_	_	_	_	_	•
Operatin	ig temperature range	-30°C to +85°C		-	-40°C to +85°C		-40°C to 90°C	-30°C to +85°C	
A	utomotive use	_	_	_	•	_	0	—	_
	Life Cycle		2	2			3	2	2
	Rating (max.) (Resistive load)		50mA 12V DC						
Electrical	Rating (min.) (Resistive load)				10 <i>µ</i> A	A IV DC			
erformance	Insulation resistance				100MΩ min.	100V DC 1min			
	Voltage proof			100V AC 1mir	۱.		250V AC 1min.	100V A	C 1min.
Jurobility	Vibration		10 to	55 to 10Hz/m in the 3 direc	nin., the amplit ation of X, Y a	ude is 1.5mm fo nd Z for 2 hours	or all the freque s respectively	encies,	
Durability	Lifetime		Shall be in accordance with individual specifications.						
	Cold	-40°C 96h							
nvironmental erformance	Dry heat	90°C 96h							
	Damp heat	60°C, 90 to 95%RH 96h							
	Page	208	209	210	211	212	213	215	216
ACT Sw	itch [™] Soldering Condition	ditions · · ·			D H	: Width. The mo : Depth. The mo : Height. The mi	st outer dimens nimum dimensi	sion excluding to on if there are v	erminal port ariances. • • • • 25

1. The automotive operating temperature range to be individually discussed upon request.

2. Indicates applicability to all products in the series, while \bigcirc indicates applicability to some products in the series.

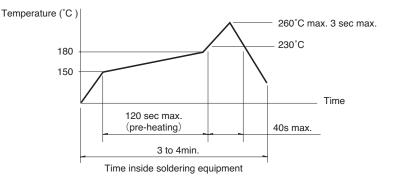
Snap-in Type

Radial Type

Condition for Reflow

Available for Surface Mount Type.

- 1. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at solder joints (copper foil surface) A heat resistive tape should be used to fix thermocouple.
- 2. Temperature profile



Notes

- 1. The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH, SKPD Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKQJ, SKQK, SKEG Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100 $\ensuremath{\mathbb{C}}$ max.
Preheating time	45s max.
Soldering temperature	255°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

Notes

1. Prevent flux penetration from the top side of the TACT Switch[™].

- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81.
- (EC-19S-8 by TAMURA Corporation, or equivalents.)

Manual Soldering

	<u> </u>
Items	Condition
Soldering temperature	350°C max.
Duration of soldering	Зs max.
Capacity of soldering iron	60W max.

SKHH, SKHW, SKRG, SKPD Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ, SKQK, SKEG Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	Зs max.
Capacity of soldering iron	20W max.

